



Printed Electronics 2017

Guest Editor:

Prof. Dr. Je Hoon Oh

Department of Mechanical
Engineering, Hanyang University
55 Hanyangdaehak-ro, Sangrok-
gu, Ansan, Gyeonggi-do 15588,
Korea

Deadline for manuscript
submissions:

closed (15 December 2017)

Message from the Guest Editor

Dear Colleagues,

Printed electronics are a new type of electronic, in which electronic system and components are directly produced on a rigid, flexible, or stretchable substrate using low-cost coating and printing processes, rather than traditional silicon-based processes. Common printing technologies can be used for printed electronics, such as inkjet, flexography, gravure, screen printing, and offset printing. Printed electronics have attracted a great interest from researchers and industry since their advent in the early 2000s, and it is still considered a very promising novel technology. The field of printed electronics is rapidly advancing from research to commercialization, and the application area is expanding from active or passive electronic components to new forms of functional electronic devices and systems, such as flexible displays, smart labels, batteries, and wearable electronics. This Special Issue on “Printed Electronics” will highlight challenges and recent advances in all areas of printed electronics.

Prof. Je Hoon Oh
Guest Editor





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Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

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